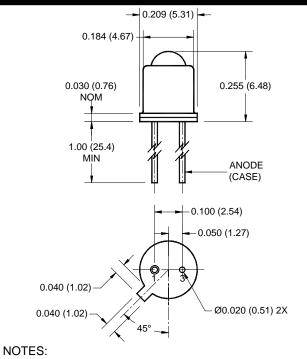


CQX14, CQX16 GaAs INFRARED EMITTING DIODE

PACKAGE DIMENSIONS



- 1. Dimensions for all drawings are in inches (mm).
- 2. Tolerance of ± .010 (.25) on all non-nominal dimensions
- unless otherwise specified.

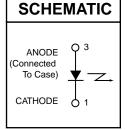
DESCRIPTION

The CQX14/16 are 940 nm LEDs in a narrow angle, TO-46 packages.

FEATURES

- Good optical to mechanical alignment
- Mechanically and wavelength matched to the TO-18 series phototransistor
- Hermetically sealed package
- High irradiance level
- European "Pro Electron" registered





- 1. Derate power dissipation linearly 1.70 mW/°C above 25°C ambient.
- 2. Derate power dissipation linearly 13.0 mW/°C above 25°C case.
- 3. RMA flux is recommended.
- 4. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 5. Soldering iron tip 1/16" (1.6mm) minimum from housing.
- 6. As long as leads are not under any stress or spring tension
- 7. Total power output, P_O , is the total power radiated by the device into a solid angle of 2 π steradians.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise specified)

Parameter	Symbol	Rating	Unit
Operating Temperature	T _{OPR}	-65 to +125	C°
Storage Temperature	T _{STG}	-65 to +150	O°
Soldering Temperature (Iron) ^(3,4,5 and 6)	T _{SOL-I}	240 for 5 sec	O°
Soldering Temperature (Flow) ^(3,4 and 6)	T _{SOL-F}	260 for 10 sec	O°
Continuous Forward Current	l _F	100	mA
Forward Current (pw, 1µs; 200Hz)	l _F	10	A
Reverse Voltage	V _R	3	V
Power Dissipation $(T_A = 25^{\circ}C)^{(1)}$	PD	170	mW
Power Dissipation $(T_C = 25^{\circ}C)^{(2)}$	PD	1.3	W

ELECTRICAL / OPTICAL CHARACTERISTICS (T_A =25°C) (All measurements made under pulse conditions)

PARAMETER	TEST CONDITIONS	SYMBOL	MIN	ТҮР	MAX	UNITS
Peak Emission Wavelength	I _F = 100 mA	λ_{P}	—	940	—	nm
Emission Angle at 1/2 Power	I _F = 100 mA	θ	—	±8	—	Deg.
Forward Voltage	I _F = 100 mA	V _F	_	—	1.7	V
Reverse Leakage Current	V _R = 3 V	I _R	_	—	10	μA
Total Power CQX14 ⁽⁷⁾	I _F = 100 mA	Po	5.4	—	—	mW
Total Power CQX16 ⁽⁷⁾	I _F = 100 mA	Po	1.5	—	—	mW
Rise Time 0-90% of output		t _r	—	1.0		μs
Fall Time 100-10% of output		t _f	_	1.0	—	μs



CQX14, CQX16 GaAs INFRARED EMITTING DIODE

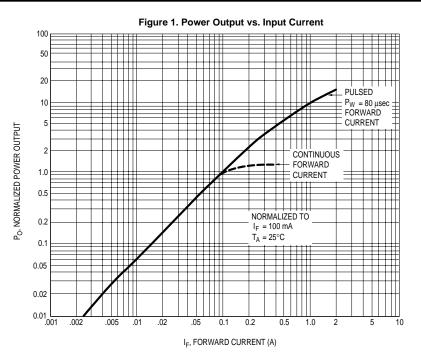


Figure 2. Power Output vs. Temperature 1.4 1.2 P₀, NORMALIZED POWER OUTPUT 1.0 0.8 0.6 NORMALIZED TO 0.4 I_F = 100 mA T_A = 25°C 0.2 0 -50 -25 25 50 75 100 125 150 0 T_A, AMBIENT TEMPERATURE (°C)

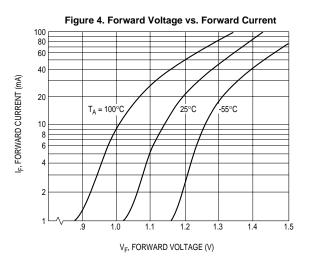
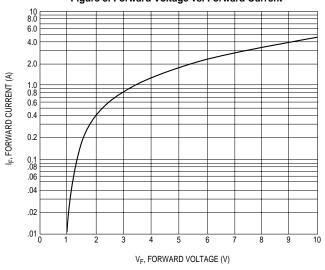
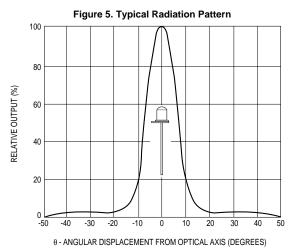


Figure 3. Forward Voltage vs. Forward Current







CQX14, CQX16 GaAs INFRARED EMITTING DIODE

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